

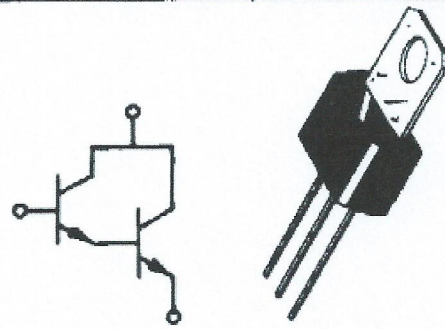
# MPS-U45 (SILICON)

## NPN SILICON DARLINGTON AMPLIFIER TRANSISTOR

... designed for amplifier and driver applications.

- High DC Current Gain –  
 $h_{FE} = 25,000$  (Min) @  $I_C = 200$  mAdc  
 $15,000$  (Min) @  $I_C = 500$  mAdc
- Collector-Emitter Breakdown Voltage –  
 $BV_{CES} = 40$  Vdc (Min) @  $I_C = 100$   $\mu$ Adc
- Low Collector-Emitter Saturation Voltage –  
 $V_{CE(sat)} = 1.5$  Vdc @  $I_C = 1.0$  Adc
- Monolithic Construction for High Reliability
- Complement to PNP MPS-U95

## NPN SILICON DARLINGTON TRANSISTOR



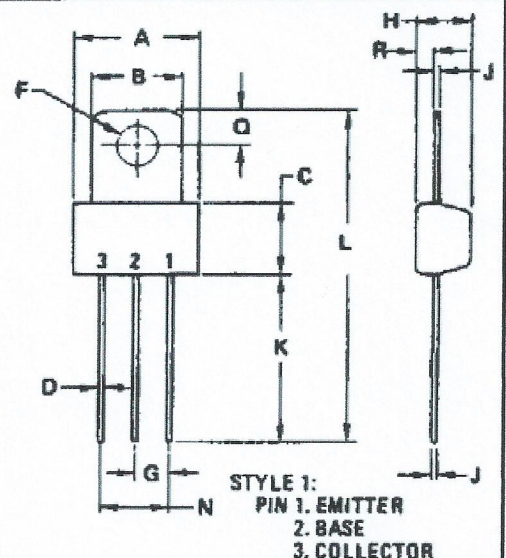
### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CES}$	40	Vdc
Collector-Base Voltage	$V_{CB}$	50	Vdc
Emitter-Base Voltage	$V_{EB}$	12	Vdc
Collector Current	$I_C$	2.0	Adc
Total Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	1.0 8.0	Watt mW/ $^\circ\text{C}$
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	10 80	Watts mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-55 to +150	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$ (1)	125	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction to Case	$R_{\theta JC}$	12.5	$^\circ\text{C}/\text{W}$

(1)  $R_{\theta JA}$  is measured with the device soldered into a typical printed circuit board.



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.14	9.53	0.360	0.375
B	6.80	7.24	0.260	0.285
C	5.41	5.85	0.213	0.223
D	0.30	0.53	0.015	0.021
F	3.18	3.33	0.125	0.131
G	2.54 BSC		0.100 BSC	
H	3.84	4.18	0.155	0.165
J	0.38	0.41	0.014	0.016
K	12.07	12.70	0.475	0.500
L	25.02	25.53	0.985	1.005
N	5.08 BSC		0.200 BSC	
Q	2.39	2.69	0.094	0.106
R	1.14	1.40	0.045	0.055

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>					
Collector-Emitter Breakdown Voltage ( $I_C = 100 \mu\text{A}$ , $V_{BE} = 0$ )	$BV_{CES}$	40	—	—	Vdc
Collector-Base Breakdown Voltage ( $I_C = 100 \mu\text{A}$ , $I_E = 0$ )	$BV_{CBO}$	50	—	—	Vdc
Emitter-Base Breakdown Voltage ( $I_E = 10 \mu\text{A}$ , $I_C = 0$ )	$BV_{EBO}$	12	—	—	Vdc
Collector Cutoff Current ( $V_{CB} = 30 \text{ Vdc}$ , $I_E = 0$ )	$I_{CBO}$	—	—	100	nAdc
Emitter Cutoff Current ( $V_{EB} = 10 \text{ Vdc}$ , $I_C = 0$ )	$I_{EBO}$	—	—	100	nAdc
<b>ON CHARACTERISTICS (1)</b>					
DC Current Gain ( $I_C = 200 \text{ mA}$ , $V_{CE} = 5.0 \text{ Vdc}$ ) ( $I_C = 500 \text{ mA}$ , $V_{CE} = 5.0 \text{ Vdc}$ ) ( $I_C = 1.0 \text{ Adc}$ , $V_{CE} = 5.0 \text{ Vdc}$ )	$h_{FE}$	25,000 15,000 4,000	65,000 35,000 12,000	150,000 — —	—
Collector-Emitter Saturation Voltage ( $I_C = 1.0 \text{ Adc}$ , $I_B = 2.0 \text{ mA}$ )	$V_{CE(sat)}$	—	1.2	1.5	Vdc
Base-Emitter Saturation Voltage ( $I_C = 1.0 \text{ Adc}$ , $I_B = 2.0 \text{ mA}$ )	$V_{BE(sat)}$	—	1.85	2.0	Vdc
Base-Emitter On Voltage ( $I_C = 1.0 \text{ Adc}$ , $V_{CE} = 5.0 \text{ Vdc}$ )	$V_{BE(on)}$	—	1.7	2.0	Vdc
<b>DYNAMIC CHARACTERISTICS</b>					
Small-Signal Current Gain (1) ( $I_C = 200 \text{ mA}$ , $V_{CE} = 5.0 \text{ Vdc}$ , $f = 100 \text{ MHz}$ )	$ h_{fe} $	1.0	3.2	—	—
Collector Base Capacitance ( $V_{CB} = 10 \text{ Vdc}$ , $I_E = 0$ , $f = 1.0 \text{ MHz}$ )	$C_{cb}$	—	2.5	6.0	pF

(1) Pulse Test: Pulse Width  $< 300 \mu\text{s}$ . Duty Cycle  $< 2.0\%$ .